1 2	i hereby certify that this correspondence is being sent by facelmile to 571-273-8300 or mailed First Class mail with sufficient postage to as follows:  Commissioner for Patents, P.O. Box 1450	RECEIVED CENTRAL FAX CENTER
3	Alexandria, VA 22313-1450 on: July 6, 2009	JUL 0 6 2009
4	Robert Moli, Registration No. 33,741	
5 6	U.S. PATENT AND TRADEMARK OFFICE	
7	In re Application of: Gien C. Shepherd et al.	Examiner: Tuan T. Dinh
8	Title: Substrate With Via and Pad Structures	Art Unit: 2841
9	Application No. 10/774,115	Attorney Docket No. Solectron 735
10	Filing Date: February 6, 2004	•
11		•
12 13	AMENDMENT	
14		
15	Commissioner for Patents	
16	P.O. Box 1450	
17	Alexandria, VA 22313-1450	
18	Dan Eventus Diek	
19	Dear Examiner Dinh:	
20	In response to the Office action dated lung 1	14 2009 places apparates amondment
21	In response to the Office action dated June 11, 2009, please enter the amendmen and consider the following remarks:	
22	and consider the following femalike.	
23		·
24		
25		
26	•	
27		
28		
29		
30		